No.P-JAE-E009/3
DATE 2026-11

PRODUCTS DATA SHEET

MICRO FUSE

Type JAE

Size 3216

UL/cUL approved
File No. E170721
RoHS COMPLIANT
LEAD FREE





Granted Patents
Japanese patent（No.4200450）

MATSUO ELECTRIC CO., LTD.

Type JAE

Type JAE micro fuse is designed for circuit protection against excessive current in portable electronic equipment, electric circuit around battery, etc. because the demand for high capacity batteries is increasing.
Wire material is adopted for fuse element, and the performance against rush current is increased in spite of compact design.
Also, the ecology design of Type JAE is environmentally friendly because of complete lead-free.

FEATURES

1. Our original construction design has excellent fusing and cutting characteristics.
2. Especially, performance against rush current is excellent since wire material is used for fuse element.
3. Surface temperature rise is 75°C or less when applying rated current for fusing. This gives less influence to the peripheral units.
4. Resistance to soldering heat : Reflow or flow soldering 10 seconds at 260°C
5. Our original terminal construction makes almost no occurrence of Tombstone phenomenon.
6. Small size of 3216 (3.2 × 1.6 × 1.4 mm)
7. Suitable for automatic mounting
8. Precise dimensions allows high-density mounting and symmetrical construction of terminals provide “Self-Alignment”.
9. Complete lead-free, bromine-free.

APPLICATION CLASSIFICATION BY USE

The application classification by use which divided the market and use into four is set up supposing our products being used for a broad use.
Please confirm the application classification by use of each product that you intend to use.
Moreover, please be sure to inform to our Sales Department in advance in examination of the use of those other than the indicated use.

RATING

Item	Rating
Category Temperature Range	-40 ~+125℃
Rated Current	0.4-0.5-0.63-0.8-1.0-1.25-1.6-2.0-2.5-3.15-4-5-6.3-8A
Rated Voltage	24VDC
Voltage Drop	Refer to CATALOG NUMBERS AND RATING
Insulation Resistance (between terminals and case)	1000 MΩ or more
Fusing Characteristics	Fusing within 2 minute if the current is 250% of rated current.
Clearing Characteristics	Breaking voltage : 24 V, 32V, 50V
	Breaking current : 50 A

ORDERING INFORMATION

JAE 2402 252 NA 52 010 ＊

Type
JAE

Code	RV
2402	24V
3202	32V
5002	50V

Code	Rated current
401	0.4 A
501	0.5 A
631	0.63A
801	0.8 A
102	1.0 A
132	1.25A
162	1.6 A

Code	Rated current
202	2.0 A
252	2.5 A
322	3.15A
402	4.0 A
502	5.0 A
632	6.3 A
802	8.0 A

Code	Package type
NA	ϕ180 Reel

Code	Case size
52	3.2×1.6

＊ Bromine-free

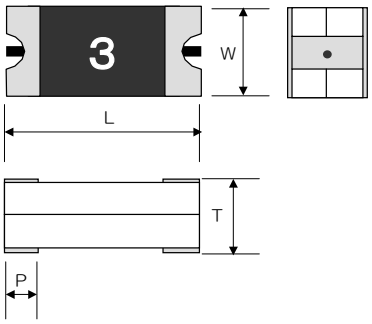
CATALOG NUMBERS AND RATING

Sep. , 2026

Catalog number	Case size	Rated current A	Internal resistance mΩ (Typical)	Voltage drop mV (Max.)	Rated voltage VDC	Breaking current A
JAE 2402 401 ☐☐52010	3.2×1.6	0.4	310	220	24	50
JAE 2402 501 ☐☐52010		0.5	240	200		
JAE 2402 631 ☐☐52010		0.63	190	150		
JAE 2402 801 ☐☐52010		0.8	145	150		
JAE 2402 102 ☐☐52010		1.0	112	150		
JAE 2402 132 ☐☐52010		1.25	87	150		
JAE 2402 162 ☐☐52010		1.6	70	150		
JAE 2402 202 ☐☐52010		2.0	54	150		
JAE 2402 252 ☐☐52010		2.5	43	150		
JAE 2402 322 ☐☐52010		3.15	34	150		
JAE 3202 402 ☐☐52010	3.2×1.6	4.0	11.6	150	32	50
JAE 3202 502 ☐☐52010		5.0	9.16	150		
JAE 3202 632 ☐☐52010		6.3	7.17	150		
JAE 3202 802 ☐☐52010		8.0	5.96	150		
JAE 5002 402 ☐☐52010	3.2×1.6	4.0	11.6	150	50	50
JAE 5002 502 ☐☐52010		5.0	9.16	150		
JAE 5002 632 ☐☐52010		6.3	7.17	150		
JAE 5002 802 ☐☐52010		8.0	5.96	150		

For the taping type, the packing code “NA” will be entered in ☐☐.
Catalog numbers are approved by UL and cUL. (File No.E170721)

DIMENSIONS



Main body : Glass epoxy
Terminal : Tin plating

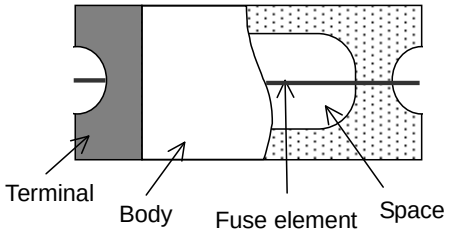
(mm)

Case size	Case code	L	W	T	P
3216	52	$3.2^{\pm 0.2}$	$1.6^{\pm 0.2}$	$1.4^{\pm 0.2}$	$0.6^{\pm 0.2}$

MARKING

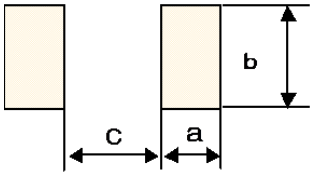
Code : Rated current	Code : Rated current	Code : Rated current
S : 0.40A	W : 1.25A	4 : 4.00A
T : 0.50A	X : 1.60A	5 : 5.00A
U : 0.63A	2 : 2.00A	6 : 6.300A
V : 0.80A	Y : 2.50A	8 : 8.00A
1 : 1.00A	3 : 3.15A	

CONSTRUCTION



Name	Material, standard, and treatment
Fuse element	Lead-free alloy
Space	—
Terminal	Tin plating
Body	Glass epoxy

RECOMMENDED PAD DIMENSIONS

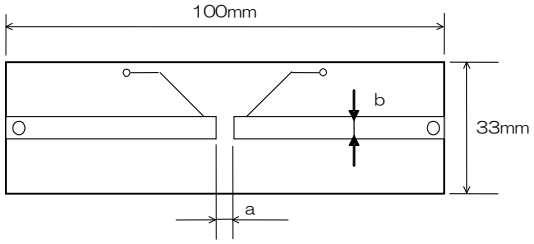


(mm)

	Size 3216
a	1.0
b	1.6
c	1.6

(Reflow)

STANDARD TEST BODY



Glass epoxy body on one side

Board thickness: 1.6mm

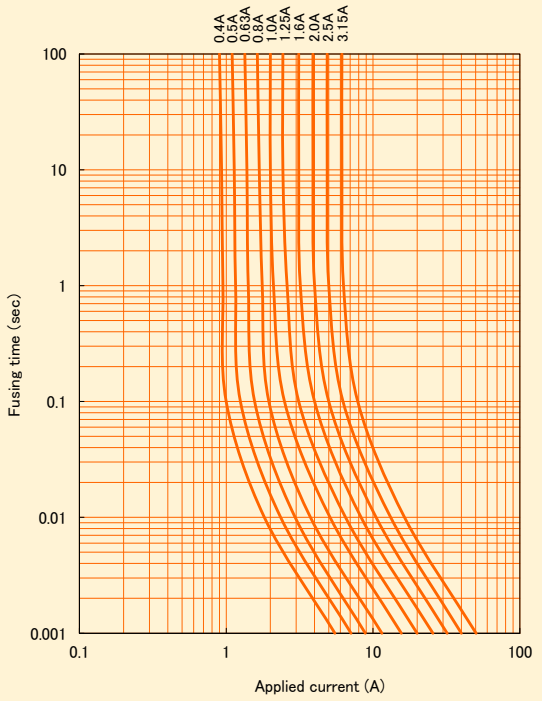
	Less than 4A	More than 4A
a	1.5mm	1.4mm
b	5mm	10mm
Copper layer	35μm	70μm

PERFORMANCE

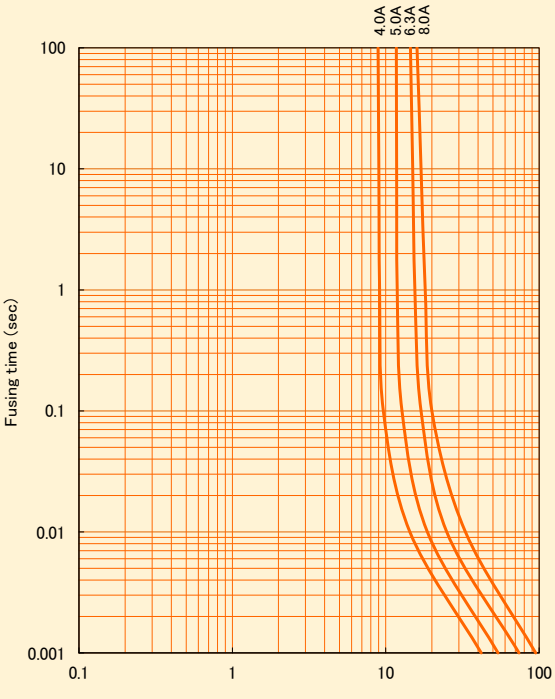
No.	Item	Performance	Test method
1	Temperature rise	Temperature rise shall not exceed 75°C.	Apply rated current.
2	Current-carrying capacity	Shall not open within 1 hour.	Apply 100% of rated current.
3	Clearing characteristics	Arc shall not be continued. Marking shall be legible.	Breaking voltage : 24V Breaking current : 50 A
4	Voltage drop	Voltage drop is below the value specified in CATALOG NUMBERS AND RATING.	Apply rated current.
5	Fusing characteristics	Fusing within 2 min.	Apply 250% of rated current. (Ambient temperature : 10 ~ 30°C)
6	Insulation resistance	1000 MΩ or more	Insulation resistance between terminals and case
7	Electrode strength (Bending)	No mechanical damage. Resistance change after the test shall be within ± 20%.	Board supporting width : 90 mm Bending speed : Approx. 0.5 mm/sec. Duration : 5 sec. Bending : 3 mm
8	Shear test	No mechanical damage. Resistance change after the test shall be within ± 20%.	Applied force : 20 N (2.04 kgf) Duration : 10 sec. Tool : R0.5 Direction of the press : side face
9	Substrate bending test	No mechanical damage. Resistance change after the test shall be within ± 20%.	Supporting dimension : 1.6 mm Applied force : 20 N (2.04 kgf) Duration : 10 sec. Tool : R0.5 Direction of the press : thickness direction of product
10	Solderability (Solder Wetting time)	Solder Wetting time : within 3sec.	Solder : Sn–3Ag–0.5Cu Temperature : 245 ± 3°C meniscograph method
			Solder : JISZ3282 H60A, H60S, H63A Temperature : 230 ± 2°C meniscograph method
11	Solderability (new uniform coating of solder)	The dipping surface of the terminals shall be covered more than 95% with new solder.	Solder : Sn–3Ag–0.5Cu Temperature : 245 ± 3°C Dipping : 3 sec.
			Solder : JISZ3282 H60A, H60S, H63A Temperature : 230 ± 2°C Dipping : 3 sec.
12	Resistance to soldering heat	Marking shall be legible. No mechanical damage. Resistance change after the test shall be within ± 20%.	Dipping (1 cycle) Preconditioning : 100 ~ 150°C, 30±5 sec. Temperature : 260 ± 3°C, 5 $^{+1}_{-0}$ sec. Reflow soldering (2 cycles) Preconditioning : 150～180°C、90±30 sec. Peak : 250 $^{+5}_{-0}$°C Holding : 230°C or higher, 30±10 sec. Cooling : 3 ~ 6°C/sec or faster Manual soldering Temperature : 350 ± 10°C Duration : 2 ~ 3 sec Measure after 1 hour left under room temperature and humidity.
13	Solvent resistance	Marking shall be legible. No mechanical damage. No significant irregularity in the appearance.	Dipping rinse Solvent : Isopropyl alcohol Duration : 90 sec.
14	Vibration	No mechanical damage. Resistance change after the test shall be within ± 20%.	Frequency range : 10 ~ 55 ~ 10 Hz/min Vibration amplitude : 1.5 mm Duration : 2 hours in each of XYZ directions (total : 6 hours)
15	Shock	No mechanical damage. Resistance change after the test shall be within ± 20%.	Peak value : 490 m/s^2(50G) Duration : 11 m sec. 6 aspects × 3 times (total : 18 times)
16	Thermal shock	No mechanical damage. Resistance change after the test shall be within ± 20%.	–55 ± 3°C : 30 min. Room temperature : 2 ~ 3 min or less 125 ± 2°C : 30 min. Room temperature : 2 ~ 3 min or less Repeat above step for 10 cycles
17	Moisture resistance	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 85 ± 3°C Humidity : 85 ± 5% RH Duration : 1000 hours
18	Load life	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 85 ± 2°C Applied current : Rated current × 100% Duration : 1000 hours
19	Moisture resistance load	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 85 ± 2°C Humidity : 85 ± 5% RH Applied voltage : rated current × 100% Duration : 1000 h
20	Stability	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 125 ± 2°C Duration : 1000 hours

FUSING CHARACTERISTICS

0.4A～3.15A

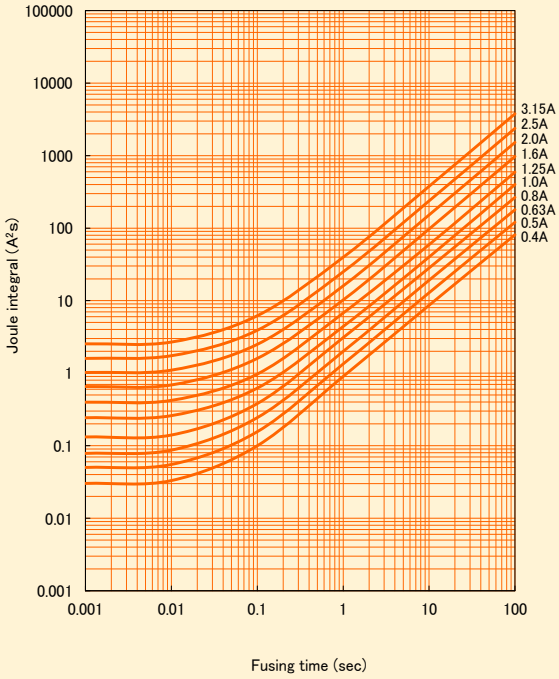


4.0A～8.0A

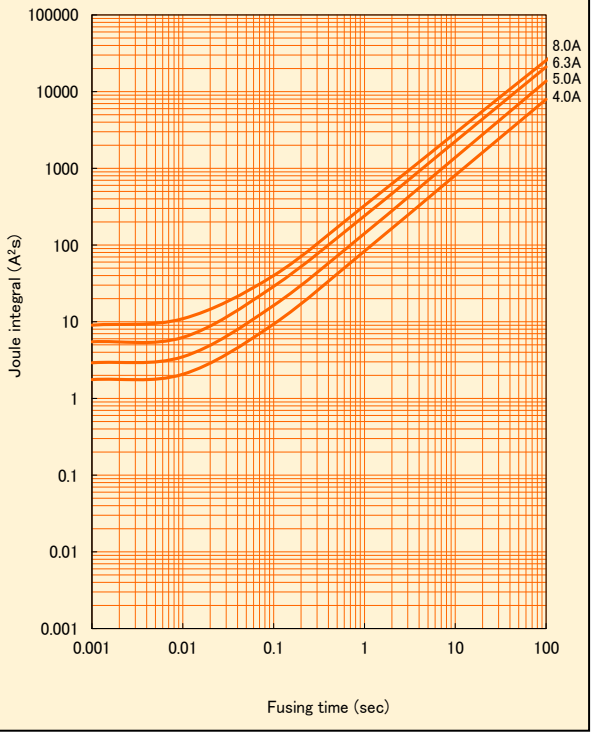


I^2T-T CHARACTERISTICS

0.4A～3.15A

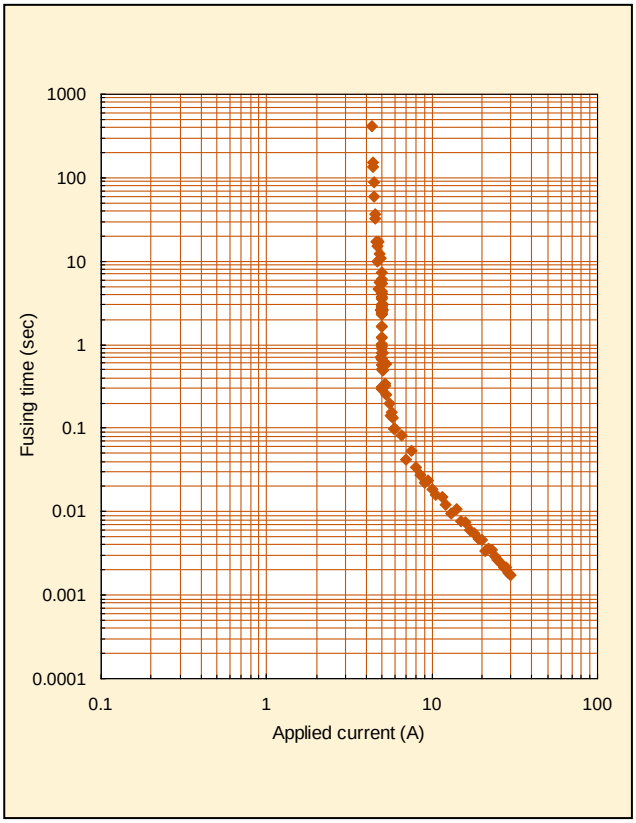


4.0A～8.0A



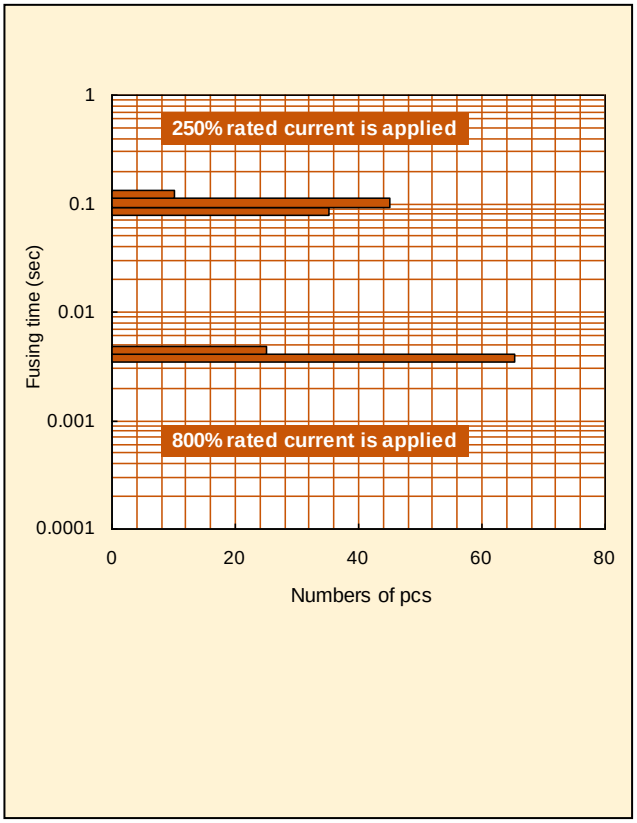
DISTRIBUTION OF FUSING CHARACTERISTICS

JAE 2402 252NA52010 n=100



DISTRIBUTION OF FUSING TIME

JAE 2402 252NA52010



DETERMINATION OF RATED VALUE AND SELECTION OF MICRO FUSE (TYPE JAE)

Determine the rated value of circuit protection element, and select the correct circuit protection element for your circuit. If you select the correct circuit protection element, safety of your circuit can be ensured.
How to determine the rated value of the circuit protection element is described below :

■Flow for fuse selection

1. Measurement of circuit values using actual device
   Measure the circuit values, such as operating current of the circuit.
2. Calculation from operating current
   From the obtained operating current and the category temperature, calculate the minimum rated value to determine the applicable fuse.
3. Calculation from overload current
   From the obtained overload current, calculate the maximum rated value to determine the applicable fuse.
4. Calculation from inrush current
   From the inrush current, calculate the minimum rated value to determine the applicable fuse.
5. Final determination of rated value
   From the calculation results of steps 2 through 4, determine the rated value.
6. Operation check using actual device
   After selecting the rating, confirm if the device works properly under the pre-determined conditions.

■ Fuse selection

1. Measurement of circuit values using actual device

Before determining the rated value of the fuse, preliminarily measure the following using the actual device.

1–1 Operating current
Using an oscilloscope or equivalents, measure the operating current of the circuit.

1–2 Overload current
Using an oscilloscope or equivalents, measure the overload current that needs to break the circuit.

1–3 Inrush current
Using an oscilloscope or equivalents, measure the inrush current of the circuit at power-on or power-off. In addition, determine the number of inrush current applied.

1–4 Category temperature
Measure the ambient temperature of the fuse circuit.

EXAMPLE TO SELECT RATINGS OF TYPE JAE
<Fuse selection>
Effective operating current : 1.2 A
Effective overload current : 6.0 A
Inrush current waveform : Fig. A
(Pulse width : 1 ms, Wave height : 6.0 A)
Numbers to withstand inrush current : 100,000 times
Category temperature : 85°C

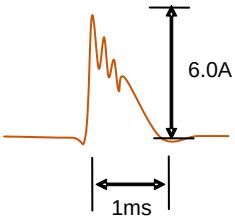


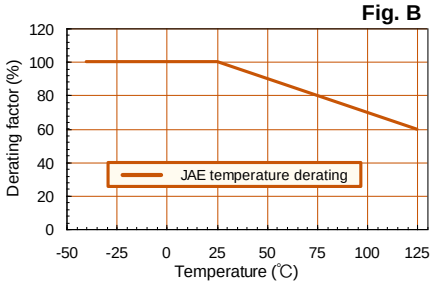
Fig. A : Inrush current waveform

2. Calculation from operating current

2–1 Measurement of operating current
Using an oscilloscope or equivalents, measure operating current (effective current) of the actual circuit.
Example : Effective operating current = 1.2 A

2–2 Derating
①Temperature derating factor
Using Fig. B, find the temperature derating factor correspond to the temperature.
②Rated derating factor
Rated derating factor = 1.0 (Constant irrespective of temperature)

Fig. B



Use Formula 1 to calculate the rated current of the fuse to be used for the circuit.
Rated current of fuse ≥ Operating current / (① × ②) ... Formula 1

Example: Category temperature = 85°C, Operating current = 1.2 A
①Temperature derating factor = 0.76 (Refer to Fig. B.)
②Rated derating factor = 1.0 (Constant irrespective of temperature)
Calculation using Formula 1 :
Rated current ≥ 1.2 / (0.76 × 1.0) = 1.58 A
The above calculation result shows that the fuse with rated current of 1.58 A or more should be selected for this circuit.

Type JAE, with rated current of 1.6 A or more can be selected.

3. Calculation from overload current

3–1 Measurement of overload current

Using oscilloscope or equivalents, measure the overload current that needs to break the circuit.

Example : Effective overload current = 6.0 A

3–2 Calculation from overload current

Determine the rated current so that the overload current can be 2.5 times larger than the rated current.

Use Formula 2 to calculate the rated current of the fuse.

Rated current of fuse ≤ Overload current / 2.5 ... Formula 2

Example : Overload current = 6.0 A

Use Formula 2 to calculate the rated current.

Rated current ≤ 6.0 / 2.5 = 2.4 A

The above calculation result shows that the fuse with rated current of 2.4 A or less should be selected for this circuit.

Type JAE, with rated current of 2.0 A or less can be selected.

4. Calculation from inrush current

4–1 Measurement of inrush current waveform

Using an oscilloscope or equivalent, measure the waveform of the inrush current of the actual circuit.

4–2 Creation of approximate waveform

Generally, the waveform of inrush current is complicated. For this reason, create the approximate waveform of inrush current as shown on Fig. C to simplify calculation.

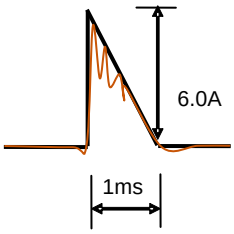


Fig. C : Inrush current waveform
Red line : Actual measurement waveform
Black line : Approximate waveform

4–3 Calculation of I^2t of inrush current

Calculate I^2t (Joule integral) of the approximate waveform.

The formula for this calculation depends on the approximate waveform.

Refer to Table A.

Example : Pulse applied = 1 ms, Peak value = 6.0 A,

Approximate waveform = Triangular wave

Since the approximate waveform is a triangular wave, use the following formula for calculation.

I^2t of rush current = $1 / 3 \times Im^2 \times t$ ... Formula 3

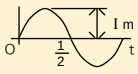
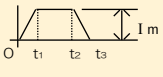
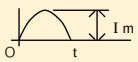
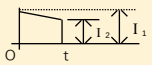
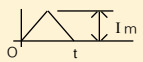
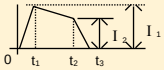
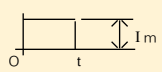
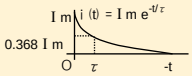
(Im : Peak value, t : Pulse applying time)

Use Formula 3 to calculate I^2t of the rush current :

$I^2t = 1 / 3 \times 6 \times 6 \times 0.001 = 0.012\ (A^2s)$

JOULE-INTEGRAL VALUES FOR EACH WAVEFORM

Table A

Name	Waveform	I^2t	Name	Waveform	I^2t
Sine wave (1 cycle)		$\frac{1}{2} I m^2 t$	Trapezoidal wave		$\frac{1}{3} I m^2 t_1 + I m^2 (t_2-t_1) + \frac{1}{3} I m^2 (t_3-t_2)$
Sine wave (half cycle)		$\frac{1}{2} I m^2 t$	Various wave 1		$I_1 I_2 t + \frac{1}{3} (I_1-I_2)^2 t$
Triangular wave		$\frac{1}{3} I m^2 t$	Various wave 2		$\frac{1}{3} I_1^2 t_1 + \{I_1 I_2 + \frac{1}{3} (I_1-I_2)^2\} (t_2-t_1) + \frac{1}{3} I_2^2 (t_3-t_2)$
Rectangular wave		$I m^2 t$	Charge/ discharge waveform		$\frac{1}{2} I m^2 t$

＊Following formula is generally used for calculation of I^2t as i(t) equal to current.

$I^2t = \int_0^t i^2(t)\, dt$

4–4 Search of load ratio

①Set up the number of cycles to withstand. (generally 100,000 times)

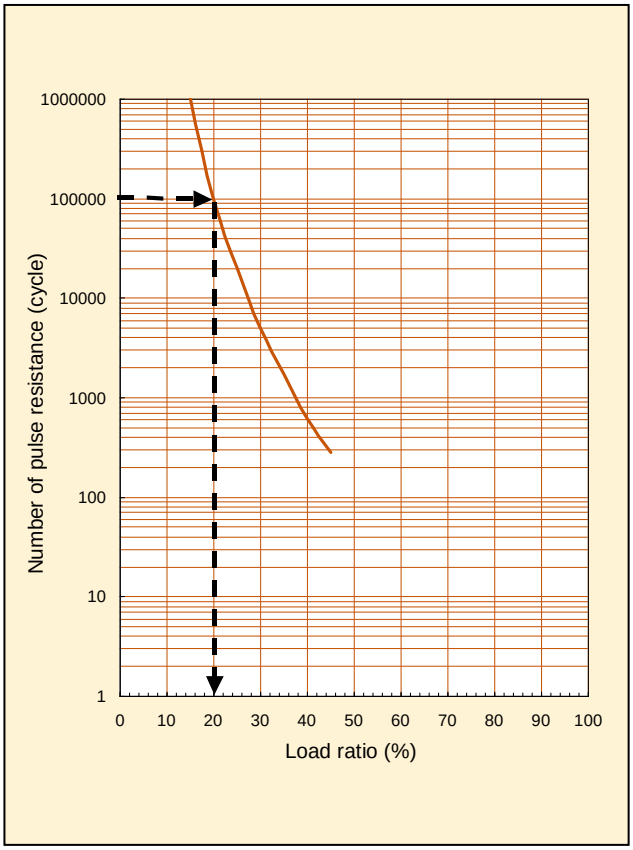
②Obtain the load ratio from Pulse resistance characteristics. (Fig. D)

Example : 100,000 times is required against inrush current applied.

The load ratio is 20% or less from Fig. D.

PULSE RESISTANCE CHARACTERISTICS

Fig. D



4–5 Calculation from Joule integral and load ratio

Use Formula 4 to calculate the standard I^2t for the fuse to be used.

Standard I^2t of fuse > (I^2t of inrush current / load ratio)
.....Formula 4

Example : I^2t of pulse = 0.012 A^2s, Pulse applied = 1 ms,
Required load ratio = 20%

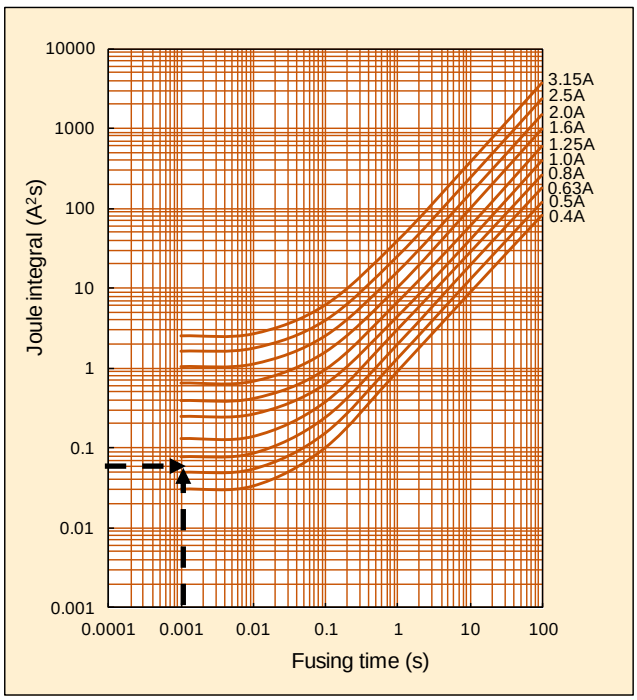
From Formula 4,
Standard I^2t of fuse > 0.012 / 0.2 = 0.06 (A^2s)
The standard I^2t of the fuse should be 0.06 (A^2s) or more.

Since the rush pulse applied is 1 ms, obtain the intersection of 1 ms (horizontal axis) and 0.06 A^2s (vertical axis) from Fig. E (refer to the arrow shown in Fig.E).

Select a fuse whose curve is above the intersection. Type JAE, with rated current of 0.63 A or more should be selected.

JOULE INTEGRAL VS. FUSING TIME

Fig. E



5. Final determination of rated value

Determine the rated current of the micro fuse. The rated current should meet all the calculation results.

Example : 1.6 A and 2.0 A meet the all requirement.

6. Operation check using actual device

After selecting the rating, confirm if the device works properly under the pre-determined conditions.

Application Notes for Micro Fuse

1. Circuit Design

Micro Fuse should be designated only after confirming operating conditions and Micro Fuse performance characteristics.
When determining the rated current, be sure to observe the following items :
(1) Micro Fuse should always be operated below the rated current (the value considered in the temperature derating rate) and voltage specifications.
(2) Micro Fuse should always be operated below the rated voltage.
(3) Micro Fuse should be selected with correct rated value to be fused at overload current.
(4) When Micro Fuse are used in inrush current applications, please confirm sufficiently inrush resistance of Micro Fuse.
(5) Please do not apply the current exceeding the breaking current to Micro Fuse.
(6) Use Micro Fuse under the condition of category temperature.
(7) Micro Fuse should not be used in the primary power source (AC side).

Micro Fuse should be selected by determining the operating conditions that will occur after final assembly, or estimating potential abnormalities through cycle testing.

2. Assembly and Mounting

During the entire assembly process, observe Micro Fuse body temperature and the heating time specified in the performance table. In addition, observe the following items :
(1) Mounting and adjusting with soldering irons are not recommended since temperature and time control is difficult.
In case of emergency for using soldering irons, be sure to observe the conditions specified in the performance table.
(2) Micro Fuse body should not contact a soldering iron directly.
(3) Once Micro Fuse mounted on the board, they should never be remounted on boards or substrates.
(4) During mounting, be careful not to apply any excessive mechanical stresses to the Micro Fuse.

3. Solvents

For cleaning of Micro Fuse, immersion in isopropyl alcohol for 90 seconds (at 20 ~ 30°C liquid temp.) will not be damaged.
If organic solvents will be used to Micro Fuse, be sure to preliminarily check that the solvent will not damage Micro Fuse .

4. Ultrasonic Cleaning

Ultrasonic cleaning is not recommended for Micro Fuse. This may cause damage to Micro Fuse such as broken terminals which results in electrical characteristics effects, etc. depending on the conditions.
If Ultrasonic cleaning process must be used, please evaluate the effects sufficiently before use.

5. Caution During Usage

(1) Micro Fuse with electricity should never be touched. Micro Fuse with electricity may cause burning due to Micro Fuse high temperature.
Also, in case of touching Micro Fuse without electricity, please check the safety temperature of Micro Fuse.
(2) Protective eyeglasses should always be worn when performing fusing tests. However, there is a fear that Micro Fuse will explode during test.
During fusing tests, please cover particles not to fly outward from the board or testing fixture. Caution is necessary during usage at all times.

6. Environmental Conditions

(1) Micro Fuse should not be stored or operated in the presence of acids, or alkalis, or corrosive atmosphere.
(2) Micro Fuse should not be vibrated, shocked, or pressed excessively.
(3) Micro Fuse should not be operated in a flammable or explosive atmosphere.
(4) Please do not use Micro fuse in the environment where dew condensation occurs.
In case Micro fuse has to be used under the dew condensation condition, please apply moisture-proof coating over Micro fuse.
Covering Micro fuse with moisture-proof coating may affect electrical characteristics, please evaluate the effects sufficiently before use.

7. Emergency

In case of fire, smoking, or offensive odor during operation, please cut off the power in the circuit or pull the plug out.

8. Storage

(1) Micro Fuse should not be stored in an environment with high temperature, low temperature, high humidity, condensation and dust and avoid direct sunlight or corrosive atmosphere such as H_2S(hydrogen sulfide) or SO_2(sulfur dioxide).
Direct sunlight may cause decolorization and deformation of the exterior and taping.
Also, solderability will be remarkably lower in high humidity.
(2) If the products are stored for an extended period of time, please contact Matsuo Sales Department for recommendation. The longer storage term causes packages and tapings to worsen. If the products will be stored for longer term, please contact us for advice.
(3) The products in taping, package, or box should not be given any kind of physical pressure. Deformation of taping or package may affect automatic mounting.
(4) The plastic reel (made of PS) used for packaging the product is intended for use in ambient temperatures (5-35℃). To prevent issues during automated insertion due to reel deformation or other factors, please keep the reel away from direct sunlight and heat sources, and ensure it does not reach high temperatures (above 60℃), including during transportation.

9. Disposal

When Micro Fuse are disposed of as waste or “scrap”, they should be treated as “industrial waste”. Micro Fuse contain various kinds of metals and resins.

10. Samples

Micro Fuse received as samples should not be used in any products or devices in the market. Samples are provided for a particular purpose such as configuration, confirmation of electrical characteristics, etc.

MATSUO ELECTRIC CO., LTD.

Please feel free to ask our Sales Department for more information on Micro Fuse.

Overseas Sales 5-3,3-Chome,Sennari-cho,Toyonaka-shi,Osaka 561-8558,Japan Tel:06-6332-0883 Fax:06-6332-0920
Head office 5-3,3-Chome,Sennari-cho,Toyonaka-shi,Osaka 561-8558,Japan Tel:06-6332-0871 Fax:06-6331-1386
URL https://www.ncc-matsuo.co.jp/

Specifications on this catalog are subject to change without prior notice. Please inquire of our Sales Department to confirm specifications prior to use.

適用用途分類 / APPLICATION CLASSIFICATION BY USE

Rev.7 (2025.10.03)

市場	適用用途分類	用途		推奨品種	推奨品種
		概要	代表的なアプリケーション例	チップタンタルコンデンサ	回路保護素子
高信頼度機器	1	・高度な安全性や信頼性が要求される機器 ・製品の保守交換が不可能な機器、製品の故障が人命に直接かかわる、または、致命的なシステムダウンを引　き起こす可能性がある機器	・宇宙開発機器関連(衛星、ロケット、人工衛星) ・航空・防衛システム ・原子力・火力・水力発電システム	267型Pシリーズ	該当なし
車載・産業機器	2	・信頼性が重視される機器 ・製品の保守交換が極めて困難な機器や、製品の故障が人命に影響する、あるいは故障の範囲が広範囲である機器	・自動車および鉄道・船舶等の輸送機器の車両制御(エンジン制御,駆動制御,ブレーキ制御) ・新幹線・主要幹線の運行制御システム	267型Nシリーズ 271型Nシリーズ	JAG型Nシリーズ JAJ型Nシリーズ JAK型Nシリーズ JHC型Nシリーズ KAB型Nシリーズ KVA型Nシリーズ
	3-A	・車載用だが一般電装機器で車室内環境において使用される機器	・エアコン,カーナビ等の車室内搭載部品、　車載用通信機器		KAB型Mシリーズ
	3-B	・製品の保守交換が可能な機器や、製品の故障が人命に影響しないが故障によるシステムダウンの損失が大きく保全管理が要求される機器	・家庭用/ビル用等のセキュリティ管理システム ・工業用ロボットや工作機械等の制御機器	267型M,Eシリーズ 279型 281型M,Eシリーズ TCA型 TCD型	JHC型
汎用機器	4	・最先端技術を積極的に適用する小型・薄型品 ・製品の保守交換が可能な機器や、製品の故障によるシステムダウンが部分的な機器向けの市場で広く使用されることを想定した製品	・スマートフォン、携帯電話、モバイルPC(タブレット)、電子辞書 ・デスクトップPC、ノートPC、ホームネットワーク ・アミューズメント機器(パチンコ、ゲーム機)	251型Mシリーズ 267型Cシリーズ TCB型	JAE型、JAG型 JAJ型、JAK型 KAB型 KAB型Tシリーズ KVA型

Market	Application classification by use	Use		Recommendation Type	Recommendation Type
		Outline	Typical example of application	Chip Tantalum Capacitors	Circuit Protection Components
High reliability apparatus	1	- Apparatus in which advanced safety and reliability are demanded. - Whether failure of the apparatus which cannot maintenance exchange products, and a product is direct for a human life, apparatus which changes or may cause a fatal system failure.	- Space development apparatus relation (Satellite, Rocket, Artificial Satellite) - Aviation and a defensive system - Atomic power, fire power, and a water-power generation system	Type 267 P Sereis	With no relevance
In-vehicle - Industrial apparatus	2	- Apparatus in which reliability is important. - The apparatus in which maintenance exchange of a product is very difficult, and failure of a product influence a human life, or the range of failure is wide range.	- Vehicles control of transport machines, such as a car, and a railroad, a vessel (Engine control, drive control, brake control) - The operation control system of the Shinkansen and a main artery	Type 267 N Sereis Type 271 N Sereis	Type JAG N series Type JAJ N series Type JAK N series Type JHC N series Type KAB N series Type KVA N series
	3-A	- General electrical equipment designed for use in vehicles but used in the interior environment	- Vehicle indoor loading parts, such as an air-conditioner and car navigation, and in-vehicle communication facility		Type KAB M series
	3-B	-Apparatus which can maintenance exchange products, and apparatus in which the loss of the system failure is large although failure of a product does not influence a human life, and maintenance engineering is demanded	- Security management system for home/buildings etc. - Control apparatus, such as Industrial use robots and a machine tool etc.	Type 267 M,E Sereis Type 279 Type 281 M,E Sereis Type TCA Type TCD	Type JHC
Apparatus in general	4	- The small size and the thin article which applies leading-edge technology positively - The product supposing being used widely in the market for the apparatus which can maintenance exchange products, and apparatus with a partial system failure by failure of product.	-Smart phone, Mobile phone, Mobile PC (tablet), Electronic dictionary - Desktop PC, Notebook PC, Home network - Amusement apparatus (Pachinko,Game machine)	Type 251 M Series Type 267 C Series Type TCB	Type JAE, Type JAG Type JAJ, Type JAK Type KAB Type KAB T series Type KVA

テーピング数量・リール寸法
Taping Quantity And Carrier Tape Dimensions

チップタンタルコンデンサ
Chip Tantalum Capacitors

定格：251型Mシリーズ, TCB型
Type：251 M Series, TCB

ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	ϕD_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330 ※1
U	1.0×0.5	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	2.0±0.05	4.0±0.1	1.55±0.03	10,000	-
M	1.6×0.8				4.0±0.1			$1.5^{+0.1}_{0}$	3,000	15,000
S	2.0×1.25									10,000
A	3.2×1.6									-

※1. 251 type only.

定格：267型Mシリーズ, 267型Eシリーズ, 267型Pシリーズ, 271Nシリーズ
279型Mシリーズ, 281型Mシリーズ, 281型Eシリーズ
Type：267 M Series, 267 E Series, 267 P Series, 271 N Series
279 M Series, 281 M Series, 281 E Series

ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	D_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330
A	3.2×1.6	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	$\phi 1.5^{+0.1}_{0}$	2,000	9,000
B	3.5×2.8									8,000
C3	6.0×3.2	12.0±0.3	5.5±0.05		8.0±0.1				500	3,000
D3	7.3×4.4		5.7±0.05	1.5±0.1						2,500
H	7.3×4.4		5.7±0.1							1,500
E	7.3×5.8		5.5±0.05	1.75±0.05						2,000

定格：267型Nシリーズ、TCA型
Type：267 N Series, TCA

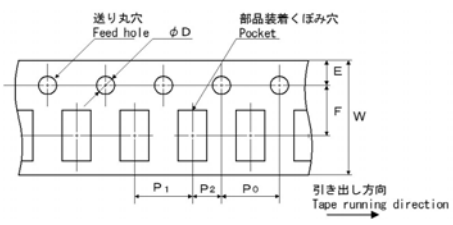
ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	D_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330
A	3.2×1.6	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	$\phi 1.5^{+0.1}_{0}$	2,000	9,000
B	3.5×2.8									8,000
C	6.0×3.2	12.0±0.3	5.5±0.05		8.0±0.1				500	3,000
D	7.3×4.4		5.7±0.05	1.5±0.1						2,500

回路保護素子
Circuit Protection Components

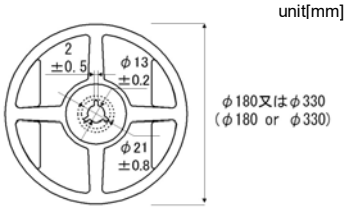
定格：JAE型、JAG型、JAG型Nシリーズ、JAJ型、JAJ型Nシリーズ、JAK型、JAK型Nシリーズ、JHC型、JHC型Nシリーズ
KAB型、KAB型Nシリーズ、KAB型Mシリーズ、KAB型Tシリーズ、KVA型、KVA型Nシリーズ
Type：JAE, JAG, JAG N Series, JAJ, JAJ N Series, JAK, JAK N Series, JHC, JHC N Series
KAB, KAB N Series, KAB M Series, KAB T Series, KVA, KVA N Series

ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	D_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330
29	1.6×0.8	8.0±0.3	3.5±0.05	1.75±0.05	4.0±0.1	2.0±0.05	4.0±0.1	ϕ1.55±0.03	5,000	-
31	2.0×1.25									-
52	3.2×1.6			1.75±0.1				ϕ1.5±0.1	2,000	-
44E	7.3×5.8	12±0.3	5.5±005		8.0±0.1			$\phi 1.5^{+0.1}_{0}$	500	1,500
26F	11.0×7.3	24±0.3	11.5±005		12.0±0.1				-	1,500
59F									-	500

テーピング寸法/Tape dimensions



リール寸法/Reel dimensions　単位[mm]
unit[mm]



チップタンタルコンデンサ テーピング形状記号
Chip Tantalum Capacitors Tape code

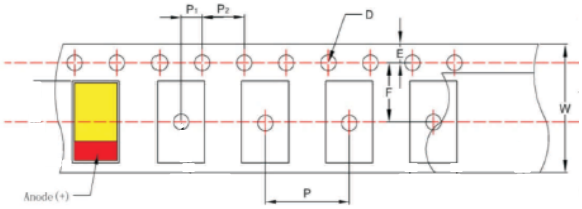
φ180リール φ180Reel	φ330リール φ330Reel	極性 Anode notation
L	P	送り穴側 ＋ Feed hole ＋
R	N	送り穴側 － Feed hole －

チップタンタルコンデンサ
Chip Tantalum Capacitors

定格：TCD型
Type：TCD

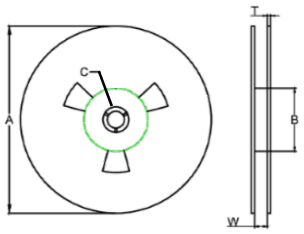
ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P (mm)	P_1 (mm)	P_2 (mm)	φD (mm)	包装数/リール(個) Quantity/Reel (pcs)
									φ180
B	3.5×2.8×2.1	8±0.30	3.5±0.05	1.75±0.10	4±0.10	4±0.10	2±0.10	1.55±0.20	2,000
D	7.3×4.3×2.8	12±0.30	5.5±0.05	1.75±0.10	4±0.10	8±0.10	2±0.10	1.55±0.20	500

テーピング寸法/Tape dimensions



単位[mm]
unit[mm]

リール寸法/Reel dimensions



リール Reel	テープ幅 Tape width	A	B	C	W	T
φ180	12	178±2.00	50 min	13.0±0.50	12.4+1.5/-0	1.50±0.50